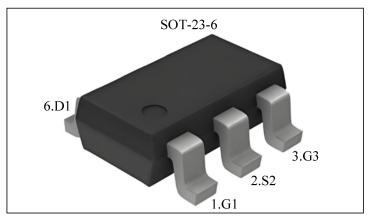


TN10H03NSG

N-Channel Enhancement Mode Power MOSFET

Features

- High density cell design for ultra low R_{DS(on)}
- Excellent package for good heat dissipation
- V_{DS}= 100V,I_D= 3A
 R_{DS(on)}< 160mΩ @V_{GS}= 10V



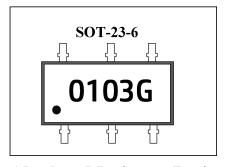
Mechanical Characteristics

- Package:SOT-23-6
- Packaging: Tape and Reel per EIA 481
- Marking : Making Code

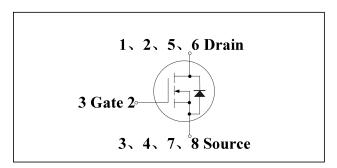
Applications

- Power switching application
- Uninterruptible power supply

Marking: Making Code



Schematic Diagram



Absolute Maximum Rating(Ratings at 25 °C ambient temperature unless otherwise specified.)

Parameter	Symbols	Value	Unit
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous	I_D	3	A
Drain Current-Pulsed Note1	I_{DM}	20	A
Junction Temperature	P_{D}	1.2	W
Maximum Power Dissipation	T _J	150	°C
Storage Temperature Range	T_{STG}	-55 to +150	°C

Thermal Characteristics

Thermal Resistance, Junction-to-Ambient Note2	$R_{ heta JA}$	104	°C/W
---	----------------	-----	------

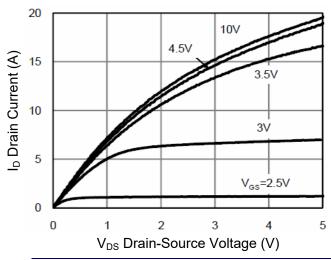
Electrical Characteristics(Tc=25°C Unless otherwise specified)

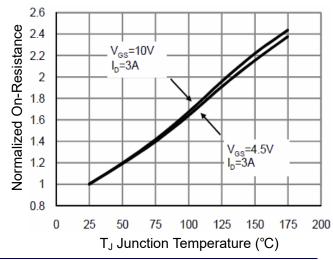
Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V,I _D =250μA	100			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V			1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
Gate Threshold Voltage Note3	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250μA	1.0	1.6	2.0	V
D : O D : 1 Noto?		V _{GS} =10V,I _D =3A		108	160	mΩ
Drain-Source On-Resistance Note3	R _{DS(on)}	V _{GS} =4.5V,I _D =3A		148	170	mΩ
Forward Transconductance Note3	g FS	V _{DS} =5V,I _D =1A		2.3		S
Dynamic Characteristics						
Input Capacitance	C _{iss}			650		pF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V,f=1MHz		24		pF
Reverse Transfer Capacitance	C _{rss}			20		pF
Switching Characteristics						
Turn-on Delay Time	t _{d(on)}			6		nS
Turn-on Rise Time	t _r	V_{DD} =50V, R_L =19 Ω V_{GS} =10V, R_{GEN} =3 Ω		4		nS
Turn-off Delay Time	t _{d(off)}			20		nS
Turn-off Fall Time	t _f			4		nS
Total Gate Charge	Qg			20		nC
Gate-Source Charge	Q _{gs}	V_{DS} =50V, I_{D} =3A, V_{GS} =10V		2.1		nC
Gate-Drain Charge	Q_{gd}			3.3		nC
Source-Drain Diode Characteristics					,	
Diode Forward Voltage Note3	V _{SD}	V _{GS} =0V,I _S =3A			1.2	V
Diode Forward Current Note2	Is				3	Α

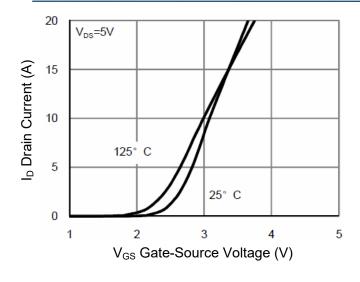
Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature. 2. Surface Mounted on FR4 Board, t ≤ 10 sec.

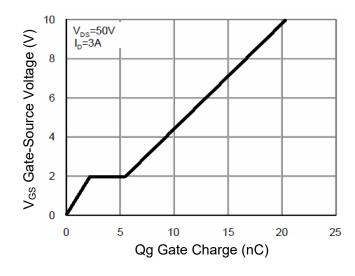
- 3. Pulse Test: Pulse width≤300µs, duty cycle≤2%.

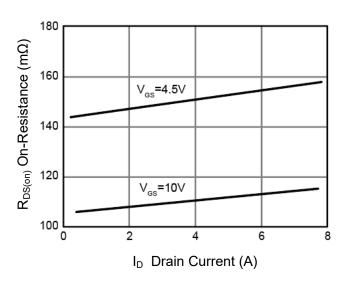
Typical Characteristics Curves

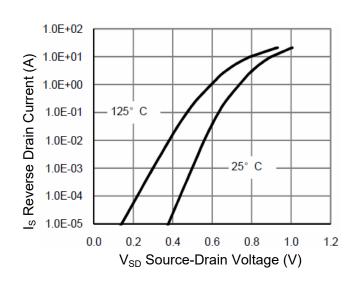


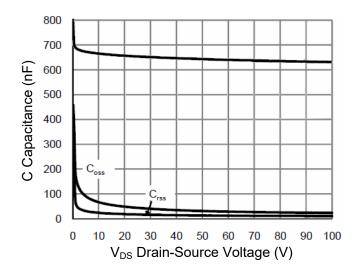


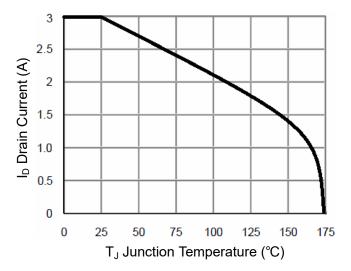


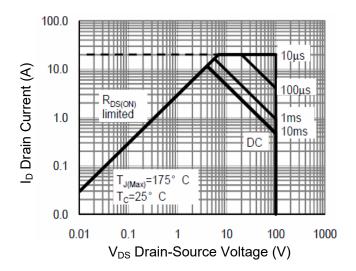


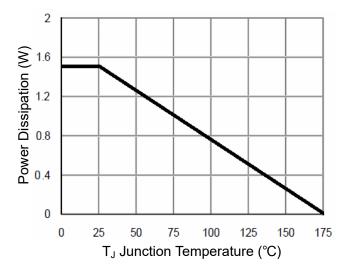


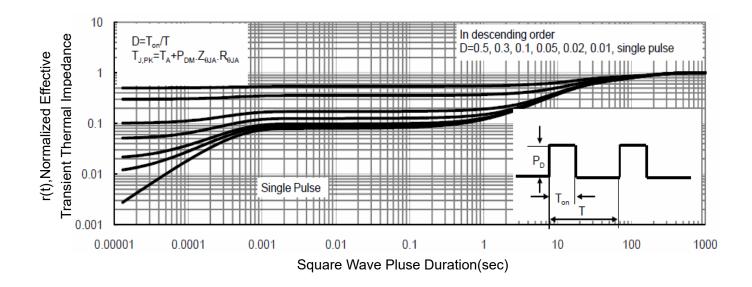




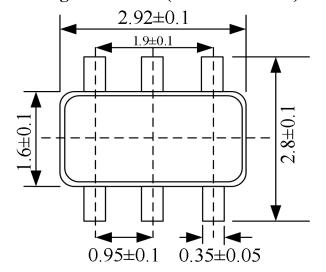


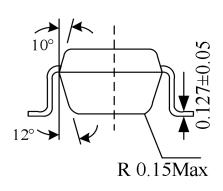


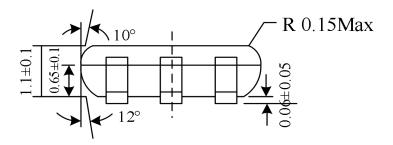




Outline Drawing – SOT-23-6(Dimensions in mm)





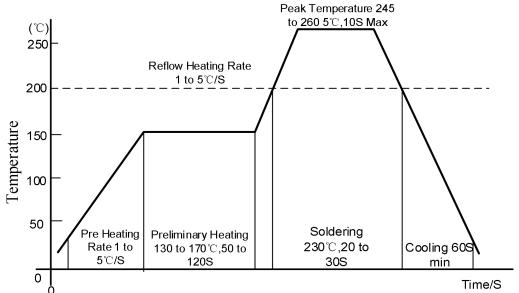


Package Information

Package Type	Description	Quantity (pcs)	Standard
SOT-23-6	Reel -7 inches	3000	EIA-481

Conditions of Soldering and Storage

Recommended condition of reflow soldering



Recommended peak temperature is over 245° C. If peak temperature is below 245° C, you may

adjust the following parameters:

- Time length of peak temperature (longer)
- Time length of soldering (longer)
- Thickness of solder paste (thicker)

Conditions of hand soldering

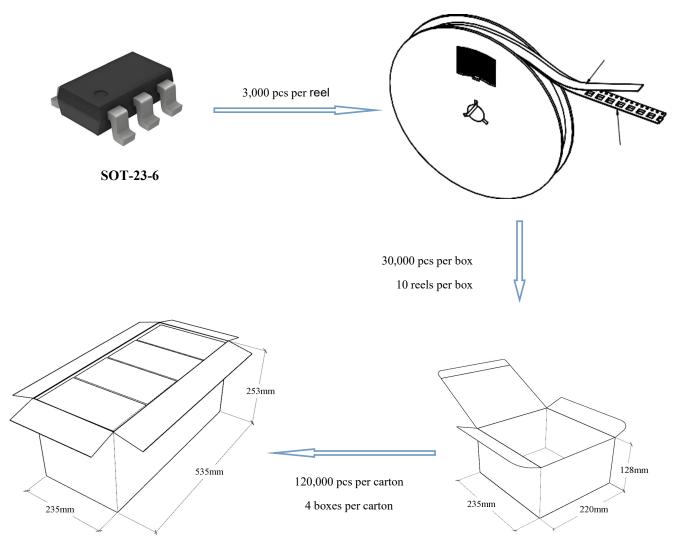
- Temperature: 300°C
- Time: 3s max
- Times: one time

Storage conditions

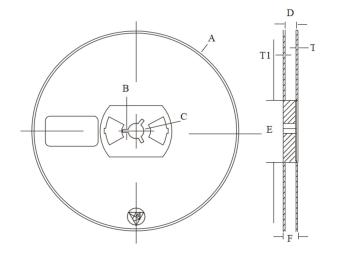
- Temperature: 5 to 40° C
- Humidity: 30 to 80% RH
- Recommended period: One year after manufacturing

Package Specifications

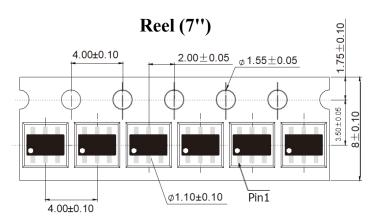
The method of packaging



Embossed tape and reel data



Symbol	Value(unit:mm)
A	Ø 177.8±1
В	2.7±0.2
С	Ø 13.5±0.2
Е	Ø 54.5±0.2
F	12.3±0.3
D	9.6+2/-0.3
T1	1.0±0.2
T2	1.2±0.2



Tape (8mm)

Contact Information

TANI website: http://www.tanisemi.com Email:tani@tanisemi.com For additional information, please contact your local Sales Representative.



® is registered trademarks of TANI Corporation.

Product Specification Statement

The product specification aims to provide users with a reference regarding various product parameters, performance, and usage. It presents certain aspects of the product's performance in graphical form and is intended solely for users to select product and make product comparisons, enabling users to better understand and evaluate the characteristics and advantages of the product. It does not constitute any commitment, warranty, or guarantee.

The product parameters described in the product specification are numerical values, characteristics, and functions obtained through actual testing or theoretical calculations of the product in an independent or ideal state. Due to the complexity of product applications and variations in test conditions and equipment, there may be slight fluctuations in parameter test values. TANI shall not guarantee that the actual performance of the product when installed in the customer's system or equipment will be entirely consistent with the product specification, especially concerning dynamic parameters. It is recommended that users consult with professionals for product selection and system design. Users should also thoroughly validate and assess whether the actual parameters and performance when installed in their respective systems or equipment meet their requirements or expectations. Additionally, users should exercise caution in verifying product compatibility issues, and TANI assumes no responsibility for the application of the product. TANI strives to provide accurate and up -to- date information to the best of our ability. However, due to technical, human, or other reasons, TANI cannot guarantee that the information provided in the product specification is entirely accurate and error-free. TANI shall not be held responsible for any losses or damages resulting from the use or reliance on any information in these product specifications.

TANI reserves the right to revise or update the product specification and the products at any time without prior notice, and the user's continued use of the product specification is considered an acceptance of these revisions and updates. Prior to purchasing and using the product, users should verify the above information with TANI to ensure that the product specification is the most current, effective, and complete. If users are particularly concerned about product parameters, please consult TANI in detail or request relevant product test reports. Any data not explicitly mentioned in the product specification shall be subject to separate agreement.

Users are advised to pay attention to the parameter limit values specified in the product specification and maintain a certain margin in design or application to ensure that the product does not exceed the parameter limit values defined in the product specification. This precaution should be taken to avoid exceeding one or more of the limit values, which may result in permanent irreversible damage to the product, ultimately affecting the quality and reliability of the system or equipment.

The design of the product is intended to meet civilian needs and is not guaranteed for use in harsh environments or precision equipment. It is not recommended for use in systems or equipment such as medical devices, aircraft, nuclear power, and similar systems, where failures in these systems or equipment could reasonably be expected to result in personal injury. TANI shall assume no responsibility for any consequences resulting from such usage.

Users should also comply with relevant laws, regulations, policies, and standards when using the product specification. Users are responsible for the risks and liabilities arising from the use of the product specification and must ensure that it is not used for illegal purposes. Additionally, users should respect the intellectual property rights related to the product specification and refrain from infringing upon any third-party legal rights. TANI shall assume no responsibility for any disputes or controv ersies arising from the above-mentioned issues in any form.